

REGULATORY COMPLIANCE



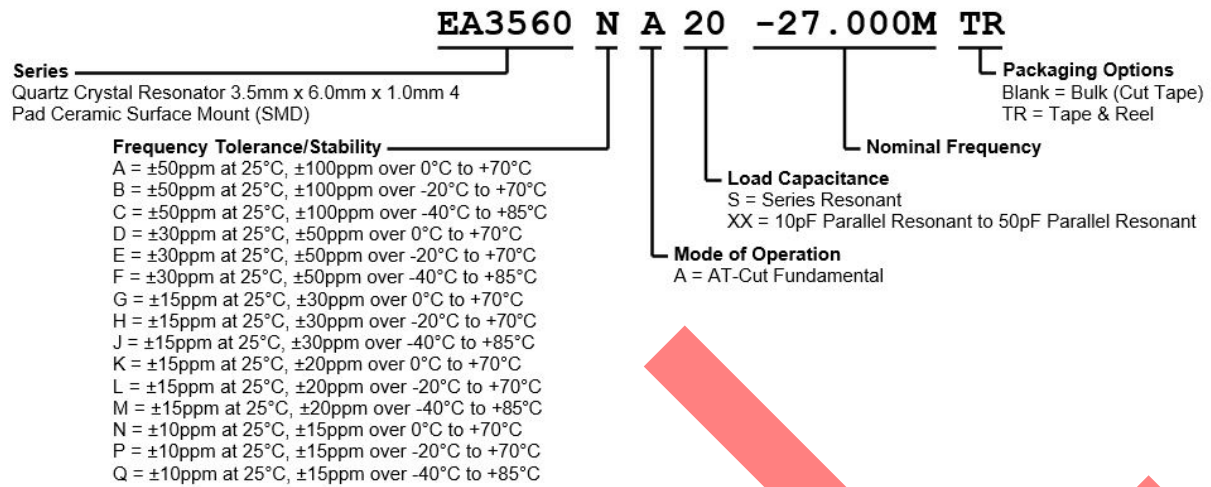
ITEM DESCRIPTION

Quartz Crystal Resonator 3.5mm x 6.0mm x 1.0mm 4 Pad Ceramic Surface Mount (SMD)

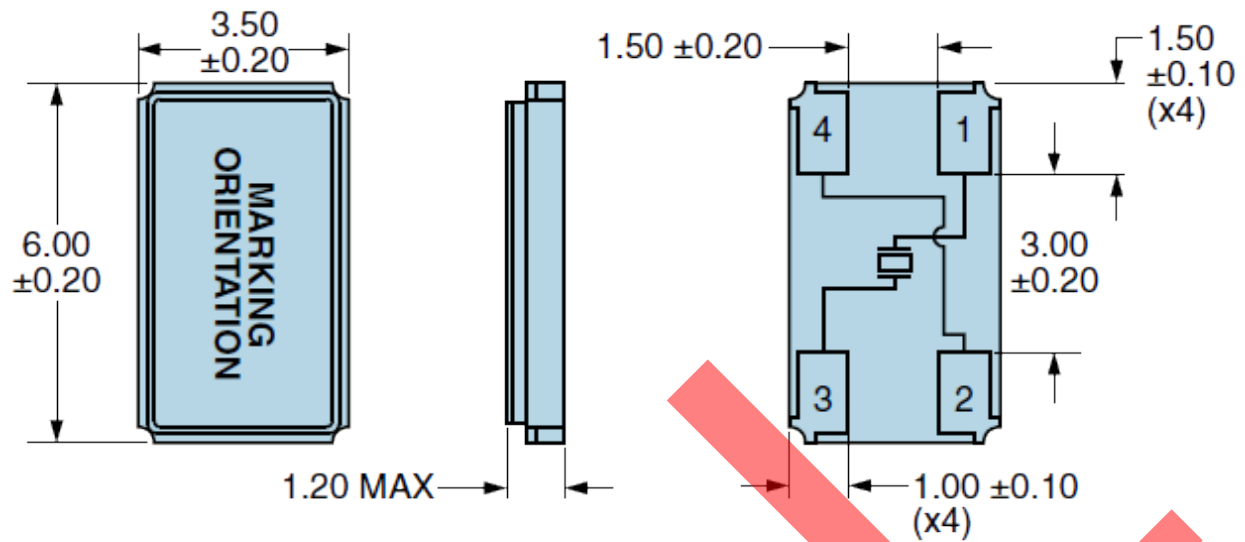
ELECTRICAL SPECIFICATIONS

Nominal Frequency	10MHz to 48MHz
Frequency Tolerance/Stability	$\pm 50\text{ppm}$ at 25°C , $\pm 100\text{ppm}$ over 0°C to $+70^{\circ}\text{C}$ $\pm 50\text{ppm}$ at 25°C , $\pm 100\text{ppm}$ over -20°C to $+70^{\circ}\text{C}$ $\pm 50\text{ppm}$ at 25°C , $\pm 100\text{ppm}$ over -40°C to $+85^{\circ}\text{C}$ $\pm 30\text{ppm}$ at 25°C , $\pm 50\text{ppm}$ over 0°C to $+70^{\circ}\text{C}$ $\pm 30\text{ppm}$ at 25°C , $\pm 50\text{ppm}$ over -20°C to $+70^{\circ}\text{C}$ $\pm 30\text{ppm}$ at 25°C , $\pm 50\text{ppm}$ over -40°C to $+85^{\circ}\text{C}$ $\pm 15\text{ppm}$ at 25°C , $\pm 30\text{ppm}$ over 0°C to $+70^{\circ}\text{C}$ $\pm 15\text{ppm}$ at 25°C , $\pm 30\text{ppm}$ over -20°C to $+70^{\circ}\text{C}$ $\pm 15\text{ppm}$ at 25°C , $\pm 30\text{ppm}$ over -40°C to $+85^{\circ}\text{C}$ $\pm 15\text{ppm}$ at 25°C , $\pm 20\text{ppm}$ over 0°C to $+70^{\circ}\text{C}$ $\pm 15\text{ppm}$ at 25°C , $\pm 20\text{ppm}$ over -20°C to $+70^{\circ}\text{C}$ $\pm 15\text{ppm}$ at 25°C , $\pm 20\text{ppm}$ over -40°C to $+85^{\circ}\text{C}$ $\pm 10\text{ppm}$ at 25°C , $\pm 15\text{ppm}$ over 0°C to $+70^{\circ}\text{C}$ $\pm 10\text{ppm}$ at 25°C , $\pm 15\text{ppm}$ over -20°C to $+70^{\circ}\text{C}$ $\pm 10\text{ppm}$ at 25°C , $\pm 15\text{ppm}$ over -40°C to $+85^{\circ}\text{C}$
Aging at 25°C	$\pm 3\text{ppm/year}$ Maximum
Load Capacitance	Series Resonant, 10pF Parallel Resonant to 50pF Parallel Resonant
Shunt Capacitance	5pF Maximum
Equivalent Series Resistance	60 Ohms Maximum over Nominal Frequency of 10MHz to 19.999999MHz 50 Ohms Maximum over Nominal Frequency of 20MHz to 34.999999MHz 40 Ohms Maximum over Nominal Frequency of 35MHz to 48MHz
Mode of Operation	AT-Cut Fundamental
Drive Level	100 μ Watts Maximum
Spurious Response	Measured from F_0 to $F_0 + 5000\text{ppm}$ -3dB Minimum
Storage Temperature Range	-40°C to $+85^{\circ}\text{C}$
Insulation Resistance	Measured at 100Vdc 500 Megaohms Minimum

PART NUMBERING GUIDE



MECHANICAL DIMENSIONS

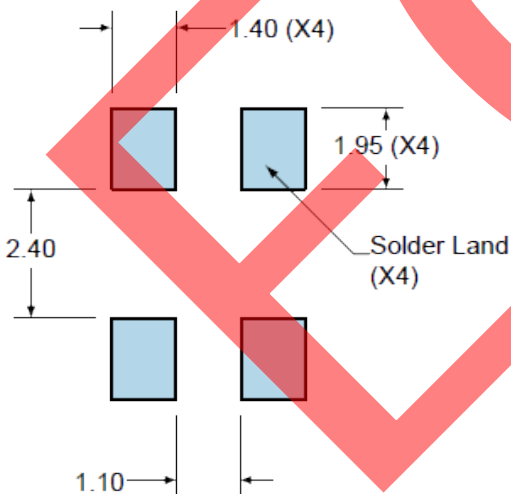


Note: Chamfer not shown.

Seam Sealed

Terminal Plating Thickness: Gold (0.3 to 1.0 μ m) over Nickel (1.27 to 8.89 μ m).

SUGGESTED SOLDER PAD LAYOUT



PIN	CONNECTION
1	Crystal
2	Case/Ground
3	Crystal
4	Case/Ground

All Tolerances are ± 0.1

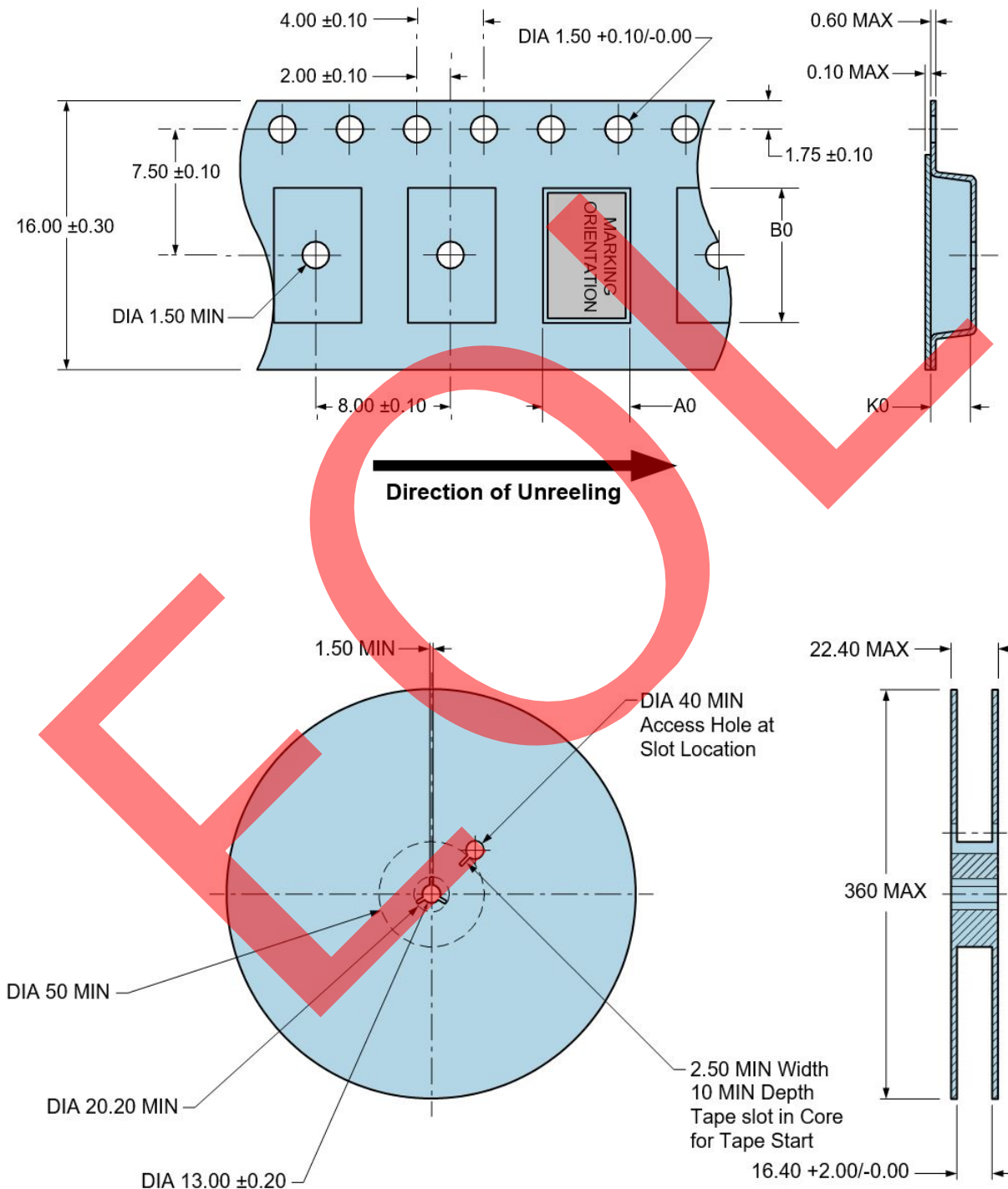
All Dimensions in Millimeters

TAPE & REEL DIMENSIONS

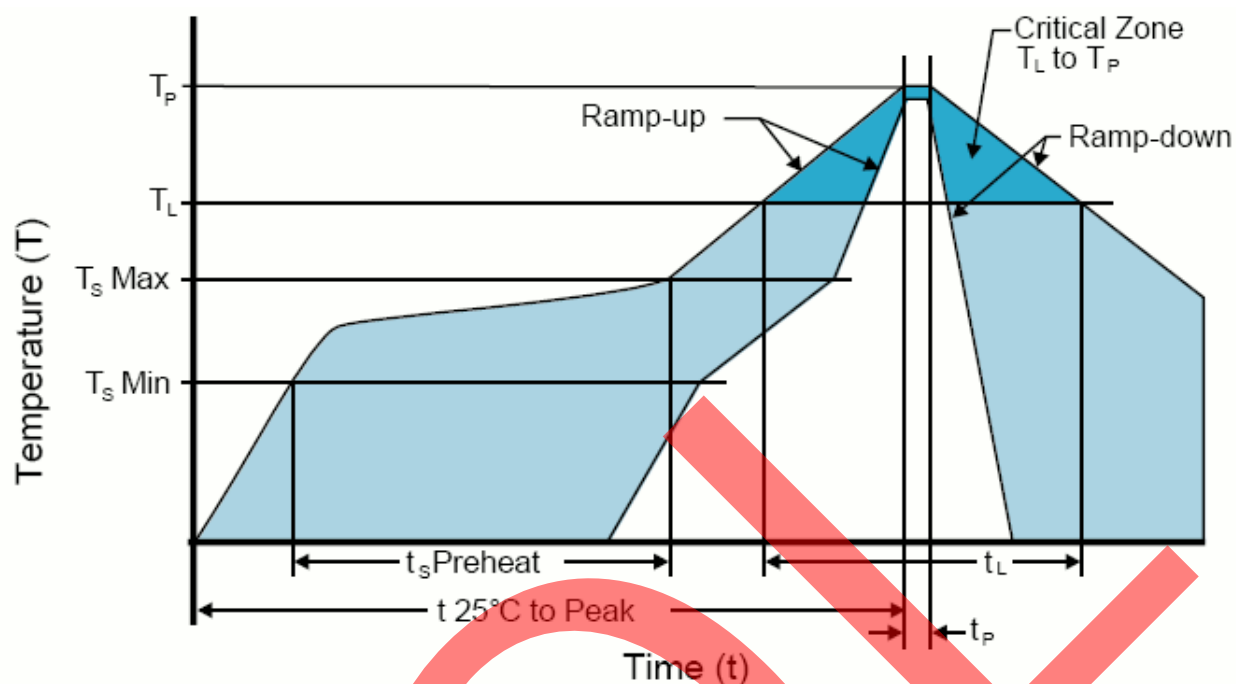
Quantity per Reel: 1,000 Units

All Dimensions in Millimeters

Compliant to EIA-481



RECOMMENDED SOLDER REFLOW METHOD



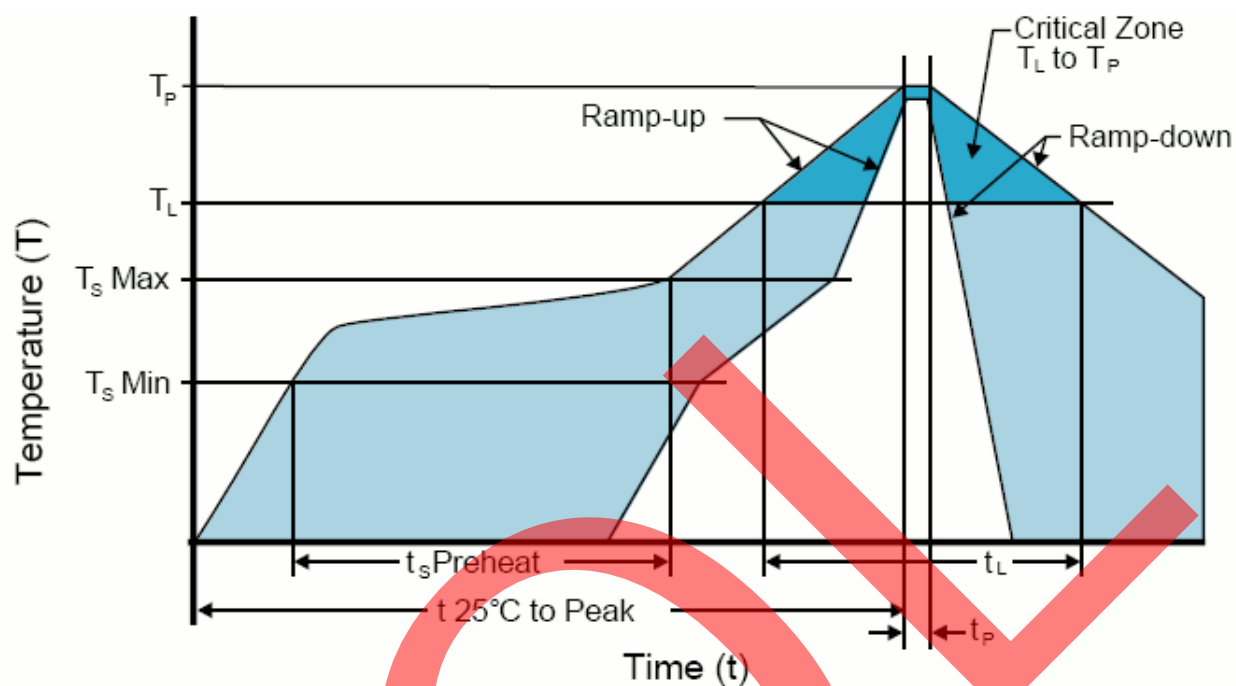
HIGH TEMPERATURE INFRARED/CONVECTION

T _s MAX to T _L (Ramp-up Rate)	3°C/Second Maximum
Preheat	
- Temperature Minimum (T _s MIN)	150°C
- Temperature Typical (T _s TYP)	175°C
- Temperature Maximum (T _s MAX)	200°C
- Time (t _s MIN)	60 - 180 Seconds
Ramp-up Rate (T _L to T _P)	3°C/Second Maximum
Time Maintained Above:	
- Temperature (T _L)	217°C
- Time (t _L)	60 - 150 Seconds
Peak Temperature (T _P)	260°C Maximum for 10 Seconds Maximum
Target Peak Temperature (T _P Target)	250°C +0/-5°C
Time within 5°C of actual peak (t _P)	20 - 40 Seconds
Ramp-down Rate	6°C/Second Maximum
Time 25°C to Peak Temperature (t)	8 Minutes Maximum
Moisture Sensitivity Level	Level 1
Additional Notes	Temperatures shown are applied to body of device.

High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)

RECOMMENDED SOLDER REFLOW METHOD



LOW TEMPERATURE INFRARED/CONVECTION

$T_S \text{ MAX to } T_L$ (Ramp-up Rate)	5°C/Second Maximum
Preheat	
- Temperature Minimum ($T_S \text{ MIN}$)	N/A
- Temperature Typical ($T_S \text{ TYP}$)	150°C
- Temperature Maximum ($T_S \text{ MAX}$)	N/A
- Time ($t_s \text{ MIN}$)	30 - 60 Seconds
Ramp-up Rate (T_L to T_P)	5°C/Second Maximum
Time Maintained Above:	
- Temperature (T_L)	150°C
- Time (t_L)	200 Seconds Maximum
Peak Temperature (T_P)	245°C Maximum
Target Peak Temperature ($T_P \text{ Target}$)	245°C Maximum 2 Times / 230°C Maximum 1 Time
Time within 5°C of actual peak (t_P)	10 Seconds Maximum 2 Times / 80 Seconds Maximum 1 Time
Ramp-down Rate	5°C/Second Maximum
Time 25°C to Peak Temperature (t)	N/A
Moisture Sensitivity Level	Level 1
Additional Notes	Temperatures shown are applied to body of device.

Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)